High Voltage with Flexible Termination System (HV FT-CAP), C0G Dielectric, 500 – 3,000 VDC (Commercial & Automotive Grade)



Overview

KEMET's High Voltage with Flexible Termination (HV FT-CAP) surface mount MLCCs in COG dielectric address the primary failure mode of MLCCs—flex cracks, which are typically the result of excessive tensile and shear stresses produced during board flexure and thermal cycling. Featuring several of the highest CV (capacitance/voltage) values available in the industry, these devices utilize a pliable and conductive silver epoxy between the base metal and nickel barrier layers of the termination system. The addition of this epoxy layer inhibits the transfer of board stress to the rigid ceramic body, therefore mitigating flex cracks which can result in low IR or short circuit failures. Although flexible termination technology does not eliminate the potential for mechanical damage that may propagate during extreme environmental and handling conditions, it does provide superior flex performance over standard termination systems.

KEMET's high voltage surface mount MLCCs in C0G dielectric feature a 125°C maximum operating temperature and offers the most stable voltage and temperature performance of all ceramic dielectric materials. C0G (NP0) dielectric capacitors exhibit no change in capacitance with respect to time and voltage and boasts a negligible change in capacitance with reference to ambient temperature. Capacitance change is limited to ±30ppm/°C from -55°C to +125°C.



Ordering Information

С	2225	X	393	J	С	G	Α	С	TU
Ceramic	Case Size (L" x W")	Specification/ Series	Capacitance Code (pF)	Capacitance Tolerance ¹	Rated Voltage (VDC)	Dielectric	Failure Rate/ Design	Termination Finish ²	Packaging/Grade (C-Spec) ³
	0805 1206 1210 1808 1812 1825 2220 2225	X= Flexible Termination	Two significant digits + number of zeros.	B = ±0.10 pF C = ±0.25 pF D = ±0.5 pF F = ±1% G = ±2% J = ±5% K = ±10% M = ±20%	C = 500 B = 630 D = 1000 F = 1500 G = 2000 Z = 2500 H = 3000	G = C0G	A = N/A	C = 100% Matte Sn L = SnPb (5% Pb minimum)	Blank = Bulk Bag (Commercial Grade) TU = 7" Reel (Commercial Grade) AUTO = 7" Reel (Automotive Grade) AUTO 7411 = 13" Reel/ Punched Paper (Automotive Grade) AUTO 7210 = 13" Reel/ Embossed Plastic (Automotive Grade)

¹ Additional capacitance tolerance offerings may be available. Contact KEMET for details.

² Additional termination finish options may be available. Contact KEMET for details.

^{2, 3} SnPb termination finish option is not available on automotive grade product.

³ Additional reeling or packaging options may be available. Contact KEMET for details.

³ Reeling tape options (Paper or Plastic) are dependent on capacitor case size (L"x W") and thickness dimension. See "Chip Thickness/Packaging Quantities" and "Tape & Reel Packaging Information" sections of this document.

³ For additional Information regarding "AUTO" C-Spec options, see "Automotive C-Spec Information" section of this document.



Automotive C-Spec Information

KEMET Automotive Grade products meet or exceed the requirements outlined by the Automotive Electronics Council. Details regarding test methods and conditions are referenced in document AEC–Q200, Stress Test Qualification for Passive Components. These products are supported by a Product Change Notification (PCN) and Production Part Approval Process warrant (PPAP).

Automotive products offered through our distribution channel have been assigned an inclusive ordering code C-Spec, "AUTO". This C-Spec was developed in order to better serve small and medium sized companies that prefer an automotive grade component without the requirement to submit a customer Source Controlled Drawing (SCD) or specification for review by a KEMET engineering specialist. This C-Spec is therefore not intended for use by KEMET's OEM Automotive customers and are not granted the same "privileges" as other automotive C-Specs. Customer PCN approval and PPAP request levels are limited (see details below).

Product Change Notification (PCN)

The KEMET Product Change Notification system is used to communicate primarily the following types of changes:

- Product/process changes that affect product form, fit, function, and /or reliability
- · Changes in manufacturing site
- Product obsolescence

KEMET Automotive	Customer Noti	fication due to:	Days prior to
C-Spec	Process/Product change	Obsolescence*	implementation
KEMET assigned ¹	Yes (with approval and sign off)	Yes	180 days Minimum
AUTO	Yes (without approval)	Yes	90 days Minimum

¹ KEMET assigned C-Specs require the submittal of a customer SCD or customer specification for review. For additional information contact KEMET.

Production Part Approval Process (PPAP)

The purpose of the Production Part Approval Process is:

- To ensure that supplier can meet the manufacturability and quality requirements for the purchased parts.
- To provide the evidence that all customer engineering design record and specification requirements are properly understood and fulfilled by the manufacturing organization.
- To demonstrate that the established manufacturing process has the potential to produce the part

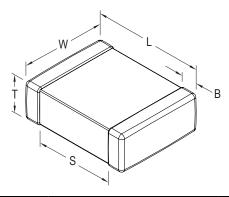
KEMET Automotive		PPAP (Product	Part Approval	Process) Level	
C-Spec	1	2	3	4	5
KEMET assigned ¹	•	•	•	•	•
AUTO	0		0		

¹ KEMET assigned C-Specs require the submittal of a customer SCD or customer specification for review. For additional information contact KEMET.

- Part Number specific PPAP available
- Product family PPAP only



Dimensions – Millimeters (Inches)



EIA Size Code	Metric Size Code	L Length	W Width	T Thickness	B Bandwidth	S Separation Minimum	Mounting Technique
0805	2012	2.00 (.079) ± 0.20 (.008)	1.25 (.049) ± 0.20 (.008)		0.50 (0.02) ± 0.25 (.010)	0.75 (.030)	Solder Wave or
1206	3216	3.30 (.130) ± 0.40 (.016)	1.60 (.063) ± 0.20 (.008)	Solder (0.008) 0.60 (.024) ± 0.25 (.010)	Solder Reflow		
1210	3225	3.30 (.130) ± 0.40 (.016)	16) 2.50 (.098) ± 0.20 (.008) 0.60 (.024) ± 0.25 (.010)				
1808	4520	4.70 (.185) ± 0.50 (.020)	2.00 (.079) ± 0.20 (.008)	See Table 2 for	0.70 (.028) ± 0.35 (.014)		
1812	4532	4.50 (.178) ± 0.40 (.016)	3.20 (.126) ± 0.30 (.012)	Thickness	0.70 (.028) ± 0.35 (.014)	N/A	Caldan Daffass Only
1825	4564	4.60 (.181) ± 0.40 (.016)	6.40 (.252) ± 0.40 (.016)		0.70 (.028) ± 0.35 (.014)		Solder Reflow Only
2220	5650	5.90 (.232) ± 0.75 (.030)	5.00 (.197) ± 0.40 (.016)	, , ,	0.70 (.028) ± 0.35 (.014)		
2225	5664	5.90 (.232) ± 0.75 (.030)	6.40 (.248) ± 0.40 (.016)		0.70 (.028) ± 0.35 (.014)		

Overview cont'd

These devices exhibit low ESR at high frequencies and find conventional use as snubbers or filters in applications such as switching power supplies and lighting ballasts. Their exceptional performance at high frequencies has made high voltage MLCC's the preferred dielectric choice of design engineers worldwide. In addition to their use in power supplies, these capacitors are widely used in industries related to automotive(hybrid), telecommunications, medical, military, aerospace, semiconductors and test/diagnostic equipment.

Automotive Grade is available for applications requiring proven, reliable performance in harsh environments. Whether under-the-hood or in-cabin, these capacitors are designed for mission and safety critical automotive circuits. Stricter testing protocol and inspection criteria have been established for automotive grade products in recognition of potentially harsh environmental conditions. KEMET automotive grade series capacitors meet the demanding Automotive Electronics Council's AEC-Q200 qualification requirements.



Benefits

- -55°C to +125°C operating temperature range
- Superior flex performance (up to 5mm)
- Lead (Pb)-Free, RoHS, and REACH compliant
- EIA 0805, 1206, 1210, 1808, 1812, 1825, 2220 and 2225 case sizes
- DC voltage ratings of 500 V, 630 V,1 KV, 1.5 KV, 2 KV, 2.5 KV and 3 KV
- Capacitance offerings ranging from 1 pF to 0.039 μF
- Available capacitance tolerances of ±0.10 pF, ±0.25 pF, ±0.5 pF, ±1%, ±2%, ±5%, ±10% and ±20%
- No piezoelectric noise
- Extremely low ESR & ESL
- · High thermal stability

- High ripple current capability
- Preferred capacitance solution at line frequencies & into the MHz range
- No capacitance change with respect to applied rated DC voltage
- Negligible capacitance change with respect to temperature from -55°C to +125°C
- No capacitance decay with time
- · Non-polar device, minimizing installation concerns
- Commercial & Automotive (AEC-Q200) grades available
- 100% pure matte tin-plated termination finish allowing for excellent solderability
- SnPb plated termination finish option available upon request (5% Pb minimum)

Applications

Typical applications include switch mode power supplies (input filters, resonators, tank circuits, snubbed circuits, output filters), high voltage coupling and DC blocking, lighting ballasts, voltage multiplier circuits, DC/DC converters and coupling capacitors in Ćuk converters. Markets include power supply, LCD fluorescent backlight ballasts, HID lighting, telecom equipment, industrial and medical equipment/control, LAN/WAN interface, analog and digital modems, and automotive.

Qualification/Certification

Commercial Grade products are subject to internal qualification. Details regarding test methods and conditions are referenced in Table 4, Performance and Reliability.

Automotive Grade products meet or exceed the requirements outlined by the Automotive Electronics Council. Details regarding test methods and conditions are referenced in document AEC–Q200, Stress Test Qualification for Passive Components. For additional information regarding the Automotive Electronics Council and AEC–Q200, please visit their website at www.aecouncil.com.

Environmental Compliance

Lead (Pb)-Free, RoHS, and REACH compliant without exemptions (excluding SnPb termination finish option).



Electrical Parameters/Characteristics

Item	Parameters/Characteristics
Operating Temperature Range	-55°C to +125°C
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	±30 ppm/°C
Aging Rate (Maximum % Capacitance Loss/Decade Hour)	0%
Dielectric Withstanding Voltage (DWV)	150% of rated voltage for voltage rating of < 1000 V 120% of rated voltage for voltage rating of ≥ 1000 V (5 ±1 seconds and charge/discharge not exceeding 50 mA)
Dissipation Factor (DF) Maximum Limit @ 25°C	0.1%
Insulation Resistance (IR) Limit @ 25°C	1000 megohm microfarads or 100 GΩ (500 VDC applied for 120 ±5 secs @ 25°C)

To obtain IR limit, divide $M\Omega$ - μ F value by the capacitance and compare to $G\Omega$ limit. Select the lower of the two limits. Capacitance and Dissipation Factor (DF) measured under the following conditions:

Note: When measuring capacitance it is important to ensure the set voltage level is held constant. The HP4284 and Agilent E4980 have a feature known as Automatic Level Control (ALC). The ALC feature should be switched to "ON."

Post Environmental Limits

	High Temperatu	ıre Life, Biased	Humidity, Mois	ture Resistance											
Dielectric	Rated DC Canacitance Dissination Factor Canacitance Insulation														
C0G	All	All	0.5	0.3% or ±0.25 pF	10% of Initial Limit										

¹ MHz ±100 kHz and 1.0 Vrms ±0.2 V if capacitance ≤ 1,000 pF

¹ kHz \pm 50 Hz and 1.0 Vrms \pm 0.2 V if capacitance > 1,000 pF



Table 1A – Capacitance Range/Selection Waterfall (0805 – 1808 Case Sizes)

			Ca	ise	Siz	ze/S	Se	ries	-	С	080	5X		С	1206	SX			С	1210	X				C	1808	3X		
				Vo	ltag	e Co	de			С	В	D	С	В	D	F	G	С	В	D	F	G	С	В	D	F	G	Z	Н
Capacitance	Cap Code		R	Rated	l Volt	tage	(VI	DC)		200	630	1000	200	630	1000	1500	2000	200	630	1000	1500	2000	200	630	1000	1500	2000	2500	3000
		C	ana	cita	anc	_ _ T	ole	rar	ICE	"				Pro	duc	t Av	ailak	oility	and	d Ch	ip Tł	nick	ness	Co	des		- 7	7	ന
1.0 - 9.1 pF*	109 - 169*	В	<u> </u>	D	1110	<u> </u>	010	, a	100	DG	DG	DG		S	ee T	able	2 fc	r Ch	nip T	hick	nes	s Di	men LB	sion LB	LB	LB	LB	LB	LB
1.0 - 9.1 pF	109 - 109			0	F	G	J	K	М	DG	DG	DG	EG	EG	EG	EG	EG	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB	LB
11 pF	110	ĺ			F	G	J	K	М	DG	DG	DG	EG	EG	EG	EG	EG	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB	LB
12 pF	120	l			F	G	J	K	M	DG	DG	DG	EG	EG	EG	EG	EG	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB	LB
13 pF	130				F	G	J	K	M	DG	DG	DG	EG	EG	EG	EG	EG	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB	LB
15 pF	150	l			F	G	J	K	M	DG	DG	DG	EG	EG	EG	EG	EG	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB	LB
16 pF	160 180				F	G	J	K	M	DG DG	DG DG	DG DG	EG EG	EG EG	EG EG	EG EG	EG EG	FM FM	FM FM	FM FM	FM FM	FM FM	LB LB	LB LB	LB LB	LB LB	LB LB	LB LB	LB LB
18 pF 20 pF	200				F	G	J	K	M	DG	DG	DG	EG	EG	EG	EG	EG	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB	LB
22 pF	220	l			F	G	J	K	M	DG	DG	DG	EG	EG	EG	EG	EG	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB	LB
24 pF	240				F	G	J	K	М	DG	DG	DG	EG	EG	EG	EG	EG	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB	LB
27 pF	270				F	G	J	K	М	DG	DG	DG	EG	EG	EG	EG	EG	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB	LB
30 pF	300				F	G	J	K	М	DG	DG	DG	EG	EG	EG	EG	EG	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB	LB
33 pF	330				F	G	J	K	М	DG	DG	DG	EG	EG	EG	EG	EG	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB	LB
36 pF	360 390				F	G	J	K	M	DG	DG	DG	EG EG	EG EG	EG EG	EG EG	EG EG	FM FM	FM	FM FM	FM FM	FM FM	LB	LB	LB	LB	LB	LB LB	LB LB
39 pF 43 pF	430	l			F	G	J	K	M	DG	DG	DG	EG	EG	EG	EG	EG	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB	LB
47 pF	470				F	G	J	K	M	DG	DG	DG	EG	EG	EG	EG	EG	FM	FM	FM	FM	FM		1			LB	LB	LB
51 pF	510	l			F	G	J	K	М	DG	DG	DG	EF	EF	EF	EG	EG	FM	FM	FM	FM	FM	A LB LB LB LB A LB LB LB LB A LB LB LB LB				LB	LB	LB
56 pF	560	İ			F	G	J	K	М	DG	DG	DG	EF	EF	EF	EG	EG	FM	FM	FM	FM	FM	M LB LB LB LE M LB LB LB LE M LB LB LB LE				LB	LB	LB
62 pF	620				F	G	J	K	М	DG	DG	DG	EF	EF	EF	EG	EG	FM	FM	FM	FM	FM	M LB LB LB LE				LB	LB	LB
68 pF	680				F	G	J	K	M	DG	DG	DG	EF	EF	EF	EG	EG	FM	FM	FM	FM	FM	A LB LB LB LB A LB LB LB				LB	LB	LB
75 pF	750				F	G	J	K	М	DG	DG	DG	EF	EF	EF	EG	EG	FM	FM	FM	FM	FM					LB	LB	LB
82 pF 91 pF	820 910				F	G	J	K	M	DG DG	DG DG	DG DG	EF EF	EF EF	EF EF	EG EG	EG EG	FM FM	FM FM	FM	FM FM	FM FM					LB LB	LB LB	LB LB
100 pF	101				F	G	J	_	M	DG	DG	DG	EF	EF	EF	EG	EG	FM	FM	FM FM	FM	FM	LB				LB	LC	LB
110 pF	111				F	G	J		M	DG	DG	DG	EF	EF	EF	EG	EG	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LC	LB
120 pF	121	l			F	G	J		М	DG	DG	DG	EF.	EF	EF	EG	EG	FG	FG	FG	FM	FM	LA	LA	LA	LA	LB	LC	LB
130 pF	131	İ			F	G	J	K	М	DG	DG	DG	EF	EF	EF	EG	EG	FG	FG	FG	FM	FM	LA	LA	LA	LA	LB	LC	LC
150 pF	151	L			F	G	J	K	М	DG	DG	DG	EF	EF	EF	EG	EG	FG	FG	FG	FM	FM	LA	LA	LA	LA	LB	LC	LC
160 pF	161				F	G	J	K	M	DG	DG	DG	EF	EF	EF	EG	EG	FG	FG	FG	FM	FM	LA	LA	LA	LA	LC	LC	LC
180 pF	181				F	G	J	K	M	DG	DG	DG	EF	EF	EF	EG	EG	FG	FG	FG	FM	FM	LA	LA	LA	LA	LC	LC	LC
200 pF 220 pF	201 221				F	G	J	K	M	DG DG	DG DG	DG DG	EF EF	EG EG	EG EG	EG EG	EG EG	FG FG	FG FG	FG FG	FM FM	FM FM	LA	LA LA	LA LA	LA LA	LC	LC LC	
240 pF	241				F	G	J	K	M	DG	DG	DG	EF	EG	EG	EG	EG	FG	FG	FG	FM	FM	LA	LA	LA	LA	LC	LC	
270 pF	271				F	G	J	K	M	DG	DG	DG	EF.	EG	EG	EG	EG	FG	FG	FG	FK	FK	LA	LA	LA	LB	LC	LC	
300 pF	301	İ			F	G	J	K	М	DG	DG		EF	EG	EG	EG		FG	FG	FG	FK	FK	LA	LA	LA	LB	LC	LC	
330 pF	331				F	G	J	K	М	DG	DG		EF	EG	EG	EG		FG	FG	FG	FK	FK	LA	LA	LA	LB	LC	LC	
360 pF	361				F	G	J	K	М	DG	DG		EG	EG	EG	EG		FG	FG	FG	FK	FS	LA	LA	LA	LB	LA	LC	
390 pF	391				F	G	J	K	M	DG	DG		EG	EG	EG	EG		FG	FG	FG	FK	FS	LA	LA	LA	LB	LA	LC	
430 pF	431 471				F	G	J	K	M	DG DG	DG DG		EG EG	EG EG	EG EG	EG EG		FG FG	FM FM	FM FM	FS FS	FS FS	LA LA	LB LB	LB LB	LC LC	LA LA		
470 pF 510 pF	511				F	G	J	K	M	DG	DG		EG	EG	EG	EG		FG	FM	FM	FS	FS	LA	LB	LB	LC	LA		
560 pF	561				F	G	J	K	M	DG	DG		EG	EG		EG		FG	FM	FM	FS	FS	LA	LB	LB	LC	LB		
620 pF	621				F	G	J	K	М	DG			EG	EG				FG	FM	FM	FS	FS	LA	LB	LB	LA	LC		
680 pF	681				F	G	J	K	М	DG			EG	EG	EG			FG	FM	FM	FS	FS	LB	LB	LB	LA	LC		
750 pF	751				F	G	J	K	М	DG			EG	EF				FG	FM	FM	FM		LB	LB	LB	LA			
820 pF	821				F	G	J	K	M	DG			EG	EF	EG			FG	FM	FM	FM		LB	LB	LB	LA			
910 pF	911				F	G	J	K	M				EG EG	EF EF	EG EG			FM	FM	FM	FY FY		LB LB	LB LB	LB	LA LB			
1,000 pF	102	\vdash)ota-			/\/!F	K K	М	200	630	1000	200	630	1000	1500	2000	₹ 000	FM 089	1000	1500	2000	200	630 FB	1000	1500	2000	2500	3000
Capacitance	Cap Code	_				_	<u> </u>	JC)		C 52	+	D	-			Ę.	02 0	-			F F	02 G	C 55	-		Ę F	02 G		8 H
		_	Rated Voltage (VDC) Voltage Code Case Size/Series			-	B 080		С	B	D 1206		G	С	B	D 1210		G	٦	В	D	1808		Z	Н				
		Case Size/Series						000	-		U	1200	^				121						1000						

^{*}Capacitance range Includes E24 decade values only. (i.e., 10, 11, 12, 13, 15, 16, 18, 20, 22, 24, 27, 30, 33, 36, 39, 43, 47, 51, 56, 62, 68, 75, 82 and 91)

KEMET reserves the right to substitute product with an improved temperature characteristic, tighter capacitance tolerance and/or higher voltage capability within the same form factor (configuration and dimensions).



Table 1A - Capacitance Range/Selection Waterfall (0805 - 1808 Case Sizes) cont'd

		(Cas	se S	Siz	e/S	eri	es		C	080	5X		C	1200	6X			С	1210	X				С	180	8X		
				Volt	age	Cod	е			С	В	D	С	В	D	F	G	С	В	D	F	G	С	В	D	F	G	Z	Н
Capacitance	Cap Code		Rat	ted \	/olta	age (VDC	:)		200	630	1000	200	630	1000	1500	2000	200	630	1000	1500	2000	200	630	1000	1500	2000	2500	3000
		Ca	рас	itaı	nce	• То	ler	and	e					Pro S	duc ee T	t Av	ailal 2 fc	oility or Cl	and	l Ch	ip TI (nes	nick s Di	ness men	s Co sior	des 15				
1,100 pF	112				F	G			М				EF	EG				FM	FK	FK	FS		LC	LC	LC	LB			
1,200 pF	122				F	G	J	K	М				EF	EG				FM	FK	FK	FS		LC	LC	LC	LC			
1,300 pF	132				F	G	J	K	М				EF	EG				FM	FS	FS			LC	LC	LC	LC			
1,500 pF	152				F	G	J	K	М				EF	EG				FK	FS	FS			LC	LC	LC	LC			
1,600 pF	162				F	G	J	K	М				EF	EG				FK	FS	FS			LC	LC	LC				
1,800 pF	182				F	G	J	K	М				EF	EG				FK	FS	FS			LC	LC	LC				
2,000 pF	202	i			F	G	J	K	М				EG	EB				FK	FL	FS			LC	LA	LB				
2,200 pF	222	i			F	G	J	ĸ	М				EG	EB				FK	FL	FS			LC	LA	LB				
2,400 pF	242	i			F	G	J	ĸ	М				EG	EB				FS	FL	FS			LC	LA	LB				
2,700 pF	272	i			F	G	J	ĸ	М				EG	EB				FS	FL	FS			LC	LA	LC				
3,000 pF	302				F	G	J	K	М				EB	EB				FS	FL				LA	LA					
3,300 pF	332	i I			FΙ	G	J	ĸ	М				EB	EB				FS	FM				LA	LA					
3,600 pF	362	i			Εĺ	G			М				EC	EC				FL	FM				LA	LB					
3,900 pF	392	i			Εĺ	G	j	ĸ	м				EC	EC				FL	FY				LA	LB					
4,300 pF	432	i			F		- 1		М				ED	ED				FM	FY				LA	LC					
4,700 pF	472				F	G	_		М				ED	ED				FM	FY				LA	LC					
5,100 pF	512				F	G			М									FY	FS				LA						
5,200 pF	562				F	G			М				İ					FY	FS				LB						
6,200pF	622				F	G			м				İ					FY	FE				LC						
6,800pF	682				F	G			М				İ					FY	FE				LC						
7,500pF	752				F	G	_		М									FS	_				ا ا						
8,200pF	822					G												FS											
						200	630	100	200	630	1000	1500	2000	200	630	1000	1500	2000	200	630	1000	1500	2000	2500	3000				
Capacitance	Cap Code						С	В	D	С	В	D	F	G	С	В	D	F	G	С	В	D	F	G	z	Н			
			Voltage Code (Case Size/Series					С	080	5X		С	1206	SX	-		С	1210	X				С	180	ЗХ				

^{*}Capacitance range Includes E24 decade values only. (i.e., 10, 11, 12, 13, 15, 16, 18, 20, 22, 24, 27, 30, 33, 36, 39, 43, 47, 51, 56, 62, 68, 75, 82 and 91)

KEMET reserves the right to substitute product with an improved temperature characteristic, tighter capacitance tolerance and/or higher voltage capability within the same form factor (configuration and dimensions).



Table 1B – Capacitance Range/Selection Waterfall (1812 – 2225 Case Sizes)

		Coop Siza/Sarian			C	104) V					C1	825	: v					<u> </u>	222	nv						222	EV		
		Case Size/Series		_		1812		_			_	1			_			_	T	222		_			_				_	
Сар	Cap	Voltage Code	С	В	D	F	G	Z	H	C 0	В	D	F	G	Z	H	C	В	D	F	G	Z	H	C	В	D	F	G	Z	H
	Code	Rated Voltage (VDC)	200	630	1000	1200	2000	2500	3000	200	. 630	90	1200	2000	2500	3000	200	630	100	1500	2000	2500	3000	200	630	1000	1500	2000	2500	3000
		Capacitance Tolerance																	Thic ss [
10 pF 11 pF	100 110	F G J K M F G J K M		GK GK	GK GK		GK GK	GK GK	GK GK								JK JK	JK JK	JK JK	JK JK	JK JK	JK JK	JK JK	KF KF	KF KF	KF KF	KF KF	KF KF	KF KF	KF KF
12 pF	120	F G J K M	GK								JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF						
13 pF	130	F G J K M		GK	GK	GK	GK	GK	GK								JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF
15 pF 16 pF	150 160	F G J K M F G J K M	GK GK	GK GK	GK GK	GK GK	GK GK	GK GK	GK GK								JK JK	JK JK	JK JK	JK JK	JK JK	JK JK	JK JK	KF KF	KF KF	KF KF	KF KF	KF KF	KF KF	KF KF
18 pF	180	F G J K M		GK	GK	GK	GK	GK	GK								JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF
20 pF	200	F G J K M		GK	GK	GK	GK	GK	GK								JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF
22 pF 24 pF	220 240	F G J K M F G J K M		GK GK	GK GK	GK GK	GK GK	GK GK	GK GK								JK JK	JK JK	JK JK	JK JK	JK JK	JK JK	JK JK	KF KF	KF KF	KF KF	KF KF	KF KF	KF KF	KF KF
27 pF	270	F G J K M	GK								JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF						
30 pF	300	F G J K M	GK								JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF						
33 pF 36 pF	330 360	F G J K M F G J K M	GK GK	GK GK	GK GK	GK GK	GK GK	GK GK	GK GK								JK JK	JK JK	JK JK	JK JK	JK JK	JK JK	JK JK	KF KF	KF KF	KF KF	KF KF	KF KF	KF KF	KF KF
39 pF	390	F G J K M	GK								JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF						
43 pF	430	F G J K M	GK								JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF						
47 pF 51 pF	470 510	F G J K M F G J K M		GK GK	GK GK	GK GK	GK GK	GK GK	GK GK								JK JK	JK JK	JK JK	JK JK	JK JK	JK JK	JK JK	KF KF	KF KF	KF KF	KF KF	KF KF	KF KF	KF KF
56 pF	560	F G J K M		GK	GK	GK	GK	GK	GK								JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF
62 pF	620	F G J K M		GK	GK	GK	GK	GK	GK								JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF
68 pF 75 pF	680 750	F G J K M F G J K M	GK GK	GK GK	GK GK	GK GK	GK GK	GK GK	GK GK								JK JK	JK JK	JK JK	JK JK	JK JK	JK JK	JK JK	KF KF	KF KF	KF KF	KF KF	KF KF	KF KF	KF KF
82 pF	820	F G J K M	GK								JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF						
91 pF	910	F G J K M	GK								JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF						
100 pF 110 pF	101 111	F G J K M F G J K M	GK GK	GK GK	GK GK	GK GK	GK GK	GK GK	GK GK								JK JK	JK JK	JK JK	JK JK	JK JK	JK JK	JK JK	KF KF	KF KF	KF KF	KF KF	KF KF	KF KF	KF KF
120 pF	121	F G J K M		GK	GK	GK	GK	GK	GK								JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF
130 pF	131	FGJKM FGJKM		GK	GK	GK	GK	GK	GK								JK	JK	JK	JK	JK	JK	JK	KF					KF	KF
150 pF 160 pF	151 161	F G J K M F G J K M	GK GK	GK GK	GK GK	GK GK	GK GK	GK GK	GK GK								JK JK	JK JK	JK JK	JK JK	JK JK	JK JK	JK JK	KF	KF	KF	KF		KF	KF KF
180 pF	181	F G J K M	GK								JK	JK	JK	JK	JK	JK	JK	KF	KF KF KF KF K <th>KF</th>					KF						
200 pF 220 pF	201 221	F G J K M F G J K M	GH GH	GH	GH GH	GH GH	GH GH	GK GK	GM GM								JK JK	JK JK	JK JK	JK JK	JK JK	JK JK	JK JK		KF KF KF KF KF K K KF KF <th>KF KF</th>					KF KF
240 pF	241	F G J K M	GH	GH GH	GH		GH	GK	GM								JK	JK	JK	JK	JK	JK	JK	KE					KE	KF
270 pF	271	F G J K M	GH	GH	GH	GH	GH	GK	GM								JK	JK	JK	JK	JK	JK	JK	KE	KF KF KF KF KF K KE KE KE KE KE K KE KE KE KE K				KE	KF
300 pF 330 pF	301 331	F G J K M F G J K M		GH GH	GH GH	GH GH	GH GH	GK GK	GM GO								JK JE	JK JE	JK JE	JK JE	JK JE	JK JK	JK JK						ΚE	KF KF
360 pF	361	F G J K M		GK	GK	GK	GH	GK	GO								JE	JE	JE	JE	JE	JK	JK	KE					KE	KF
390 pF	391	F G J K M	GK	GK	GK	GK	GK	GK	GO								JE	JE	JE	JE	JE	JK	JK	KE	KE	KE	KE	KE	KE	KF
430 pF 470 pF	431 471	F G J K M	GK		GK		GK	GK GK								HJ	JE JE	JE JE	JE JE	JE JE	JE JE	JK JK	JE JK	KE			_	_	KE	KF KF
510 pF	511	F G J K M				GK										HJ	JK	JK	JK	JK	JK	JK	JK	KF	KF KF KF KF KE KE					KF
560 pF	561	F G J K M	GH	GH	GH	GK	GH	GM								HJ	JK	JK	JK	JK	JK	JK	JL	KF	KF	KF	KF	KE	KE	KF
620 pF 680 pF	621 681	F G J K M F G J K M				GK GK										HK HK		JK JE		JK JK	JK JK	JK JK	JL JL	KF KF	KF KF	KF KF	KF KF	KE KE		KH KH
750 pF	751	F G J K M		GH				30								TIK	JE	JE		JK	JK	JK	JL	KE	KE	KE		KE		КН
820 pF	821	F G J K M	GH	GH	GH	GK	GK										JE	JE	JE	JK	JK	JK	JN	KE	KE	KE	KF	KE	KF	KJ
910 pF 1,000 pF	911 102	F G J K M F G J K M	GH	GH	GH	GH GH											JE JE	JK JK	1	JK JK	JK JK	JK JK	JN JN	KE KE		KE KE		KE KE	KF KF	KJ KJ
1,000 pF 1,100 pF	112	F G J K M	GH	GK	GK	GH	GO								HJ		JE	JK	JK	JK	JK	JK		KE		KE	KF	KF	KF	
		Rated Voltage (VDC)	200	630	1000	1500	2000	2500	3000	200	630	1000	1500	2000	2500	3000	200	630	1000	1500	2000	2500	3000	200	630	1000	1500	2000	2500	3000
Сар	Cap Code	Voltage Code	С	В	D	F	G	Z	Н	С	В	D	F	G	Z	Н	С	В	D	F	G	Z	Н	С	В	D	F	G	Z	Н
		Case Size/Series			C,	1812	2X					C1	825	X					C	222	0X					C	222	5X		

^{*}Capacitance range Includes E24 decade values only. (i.e., 10, 11, 12, 13, 15, 16, 18, 20, 22, 24, 27, 30, 33, 36, 39, 43, 47, 51, 56, 62, 68, 75, 82 and 91)

KEMET reserves the right to substitute product with an improved temperature characteristic, tighter capacitance tolerance and/or higher voltage capability within the same form factor (configuration and dimensions).

Table 1B - Capacitance Range/Selection Waterfall (1812 - 2225 Case Sizes) cont'd

		Case Size/Series			C,	181	2X					C1	182	5X					C2	222	0X					C2	222	5X		
	Cap	Voltage Code	С	В	D	F	G	Z	Н	С	В	D	F	G	z	Н	С	В	D	F	G	z	Н	С	В	D	F	G	z	Н
Сар	Code	Rated Voltage (VDC)	200	630	1000	1500	2000	2500	3000	200	630	1000	1500	2000	2500	3000	200	630	1000	1500	2000	2500	3000	200	630	1000	1500	2000	2500	3000
		Capacitance Tolerance																	Thic ss [
1,200 pF	122	F G J K M	GH	GK		GH									HJ		JE	JK	JK	JK	JK	JL		KE	KE	KE	KF	KF	KF	
1,300 pF	132	F G J K M	GH		GK	GH	GO							HE	HJ		JE	JK	JK	JK	JE	JL		KE	KE	KE	KF	KF	KH	
1,500 pF	152	F G J K M	GK	GK	GK	GK	GO							HE	HK		JE	JK	JK	JK	JE	JL		KE	KE	KE	KF	KF	KH	
1,600 pF	162	F G J K M	GK			GK								HG	HK		JE	JK	JK	JK	JE	JL		KE	KE	KE	KF	KE	KH	
1,800 pF	182	F G J K M	GK	GK	GK									HG			JE	JK	JK	JK	JE	JN		KE	KE		KF	KE	KH	
2,000 pF	202	F G J K M			GK					<u> </u>			HE	HJ			JE	JK	JK	JE	JK			KE	KE		KF	KE	KJ	
2,200 pF	222	F G J K M			GK								HE	HJ			JE	JK	JK	JE	JK			ΚE	KE		KF	KF	KJ	
2,400 pF	242	F G J K M	GK	GH	GK					<u> </u>			HE	HJ			JK	JK	JK	JE	JL			KE	KE		KE	KH		
2,700 pF	272	F G J K M			GK	G0							HE	HK			JK	JK	JK	JE	JL			ΚE	KE		KE			
3,000 pF	302	F G J K M	GK	GH	GK								HE	HK			JK	JK	JK	JE	JL			ΚE	KE		KE	KH		
3,300 pF	332	F G J K M	GK	GH	GK								HG				JK	JK	JK	JK	JN			KE	KE		KE	KJ		
3,600 pF	362	F G J K M	GK	GH	GM								HG				JK	JK	JK	JK	JN			KE	KE KE KF KE K KE KE KF KF KF KF KE KE KE KF KF <td></td>					
3,900 pF	392	F G J K M	GK	GH	GM								HJ				JK	JK	JK	JK	JN			KE	KE					
4,300 pF	432	F G J K M	GH	GH	GO								HJ				JK	JK	JK	JK				KE	KE					
4,700 pF	472	F G J K M	GH	GH	GO								HJ				JK	JK	JK	JL				KE						
5,100 pF	512	F G J K M	GH	GK	GO						HE	HG	HK				JK	JK	JK	JL				KE	KF	KF	KH			
5,600 pF	562	F G J K M	GH	GK	GO						HE	HG	HK				JK	JK	JK	JN				KE	KF		KH			
6,200 pF	622	F G J K M								<u> </u>	HE	HG					JK	JE	JE	JN				KE						
6,800 pF	682	F G J K M	GH	GM							HE	HJ					JK	JE	JK	JN				ΚE	KF		KJ			
7,500 pF	752	F G J K M	GH	GM							HE	HJ					JK	JE	JK					KF						
8,200 pF	822	F G J K M								l	HE	HJ					JK	JE	JL					KF						
9,100 pF	912	F G J K M	GM	GO						HE	HG	HK					JE	JE	JL					KF	KE	KH				
10,000 pF	103	F G J K M	GM	GO						HE	HG	HK					JE	JE	JL					KF	KE	KH				
12,000 pF	123	F G J K M	GO							HE	HG						JE	JK	JN					KE	KE	KH				
15,000 pF	153	F G J K M	GO							HE	HJ						JE	JL						KE	KF	KJ				
18,000 pF	183	F G J K M								HG	HK						JE	JL						KE	KH					
22,000 pF	223	F G J K M								HJ							JK	JN						KF	KJ					
27,000 pF	273	F G J K M								HJ							JL	JN						KF	KF KJ					
33,000 pF	333	F G J K M								НК							JN							KH						
39,000 pF	393	F G J K M																						KJ						
		Rated Voltage (VDC)	200	630	1000	1500	2000	2500	3000	200	630	1000	1500	2000	2500	3000	200	630	1000	1500	2000	2500	3000	200	630	2500	3000			
Сар	Cap Code	Voltage Code	С	В	D	F	G	Z	Н	С	В	D	F	G	z	Н	С	В	D	F	G	z	Н	С	В	Z	Н			
	Ooue	Case Size/Series			C	181:	2X					C.	182	5X					C	2220	ΟX					C	222	5X		

^{*}Capacitance range Includes E24 decade values only. (i.e., 10, 11, 12, 13, 15, 16, 18, 20, 22, 24, 27, 30, 33, 36, 39, 43, 47, 51, 56, 62, 68, 75, 82 and 91)

KEMET reserves the right to substitute product with an improved temperature characteristic, tighter capacitance tolerance and/or higher voltage capability within the same form factor (configuration and dimensions).



Table 2 – Chip Thickness/Packaging Quantities

Thickness	Case	Thickness ±	Paper G	Quantity	Plastic (Quantity
Code	Size	Range (mm)	7" Reel	13" Reel	7" Reel	13" Reel
DG	805	1.25 ± 0.15	0	0	2,500	10,000
EB	1206	0.78 ± 0.10	4000	10000	4,000	10,000
EF	1206	1.20 ± 0.15	0	0	2,500	10,000
EG	1206	1.60 ± 0.15	0	0	2,000	8,000
EC	1206	0.90 ± 0.10	0	0	4,000	10,000
ED	1206	1.00 ± 0.10	0	0	2,500	10,000
FE	1210	1.00 ± 0.10	0	0	2,500	10,000
FG	1210	1.25 ± 0.15	0	0	2,500	10,000
FL	1210	1.40 ± 0.15	0	0	2,000	8,000
FM	1210	1.70 ± 0.20	0	0	2,000	8,000
FY	1210	2.00 ± 0.20	0	0	2,000	8,000
FK	1210	2.10 ± 0.20	0	0	2,000	8,000
FS	1210	2.50 ± 0.30	0	0	1,000	4,000
LA	1808	1.40 ± 0.15	0	0	1,000	4,000
LB	1808	1.60 ± 0.15	0	0	1,000	4,000
LC	1808	2.00 ± 0.15	0	0	1,000	4,000
GH	1812	1.40 ± 0.15	0	0	1,000	4,000
GK	1812	1.60 ± 0.20	0	0	1,000	4,000
GM	1812	2.00 ± 0.20	0	0	500	2,000
GO	1812	2.50 ± 0.20	0	0	500	2,000
HE	1825	1.40 ± 0.15	0	0	1,000	4,000
HG	1825	1.60 ± 0.20	0	0	1,000	4,000
HJ	1825	2.00 ± 0.20	0	0	500	2,000
HK	1825	2.50 ± 0.20	0	0	500	2,000
JE	2220	1.40 ± 0.15	0	0	1,000	4,000
JK	2220	1.60 ± 0.20	0	0	1,000	4,000
JL	2220	2.00 ± 0.20	0	0	500	2,000
JN	2220	2.50 ± 0.20	0	0	500	2,000
KE	2225	1.40 ± 0.15	0	0	1,000	4,000
KF	2225	1.60 ± 0.20	0	0	1,000	4,000
KH	2225	2.00 ± 0.20	0	0 0	500	2,000
KJ Thickness	2225 Case	2.50 ± 0.20 Thickness ±	0 7" Reel	13" Reel	500 7" Reel	2,000 13" Reel
Code	Size	Range (mm)	Paper G	Quantity	Plastic (Quantity

Package quantity based on finished chip thickness specifications.



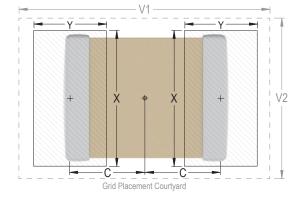
Table 3 – Chip Capacitor Land Pattern Design Recommendations per IPC-7351

EIA Size Code	Metric Size Code		Maxi	sity Lev mum (M rotrusio	/lost))		Media	sity Lev an (Nor rotrusio					sity Lev mum (L rotrusio	east))
Code	Code	С	Υ	X	V1	V2	С	Y	X	V1	V2	С	Υ	Х	V1	V2
0805	2012	1.00	1.35	1.55	4.40	2.60	0.90	1.15	1.45	3.50	2.00	0.75	0.95	1.35	2.80	1.70
1206	3216	1.60	1.65	1.90	5.90	2.90	1.50	1.45	1.80	5.00	2.30	1.40	1.25	1.70	4.30	2.00
1210	3225	1.60	1.65	2.80	5.90	3.80	1.50	1.45	2.70	5.00	3.20	1.40	1.25	2.60	4.30	2.90
1808	4520	2.30	1.75	2.30	7.40	3.30	2.20	1.55	2.20	6.50	2.70	2.10	1.35	2.10	5.80	2.40
1812	4532	2.10	1.80	3.60	7.00	4.60	2.00	1.60	3.50	6.10	4.00	1.90	1.40	3.40	5.40	3.70
1825	4564	2.15	1.80	6.90	7.10	7.90	2.05	1.60	6.80	6.20	7.30	1.95	1.40	6.70	5.50	7.00
2220	5650	2.85	2.10	5.50	8.80	6.50	2.75	1.90	5.40	7.90	5.90	2.65	1.70	5.30	7.20	5.60
2225	5664	2.85	2.10	6.90	8.80	7.90	2.75	1.90	6.80	7.90	7.30	2.65	1.70	6.70	7.20	7.00

Density Level A: For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes. KEMET only recommends wave soldering of EIA 0603, 0805 and 1206 case sizes.

Density Level B: For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes. **Density Level C:** For high component density product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC Standard 7351 (IPC–7351).

Image below based on Density Level B for an EIA 1210 case size.





Soldering Process

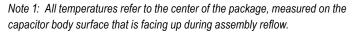
Recommended Soldering Technique:

- Solder wave or solder reflow for EIA case sizes 0603, 0805 and 1206
- · All other EIA case sizes are limited to solder reflow only

Recommended Reflow Soldering Profile:

KEMET's families of surface mount multilayer ceramic capacitors (SMD MLCCs) are compatible with wave (single or dual), convection, IR or vapor phase reflow techniques. Preheating of these components is recommended to avoid extreme thermal stress. KEMET's recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/J-STD-020 standard for moisture sensitivity testing. These devices can safely withstand a maximum of three reflow passes at these conditions.

Profile Feature	Terminati	ion Finish		
Frome reature	SnPb	100% Matte Sn		
Preheat/Soak				
Temperature Minimum (T _{Smin})	100°C	150°C		
Temperature Maximum (T _{Smax})	150°C	200°C		
Time (t_s) from T_{smin} to T_{smax}	60 – 120 seconds	60 – 120 seconds		
Ramp-Up Rate (T _L to T _P)	3°C/second maximum	3°C/second maximum		
Liquidous Temperature (T _L)	183°C	217°C		
Time Above Liquidous (t _L)	60 – 150 seconds	60 – 150 seconds		
Peak Temperature (T _P)	235°C	260°C		
Time Within 5°C of Maximum Peak Temperature (t _P)	20 seconds maximum	30 seconds maximum		
Ramp-Down Rate (T _P to T _L)	6°C/second maximum	6°C/second maximum		
Time 25°C to Peak Temperature	6 minutes maximum	8 minutes maximum		



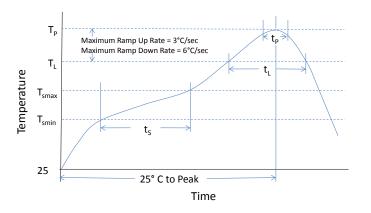




Table 4 – Performance & Reliability: Test Methods and Conditions

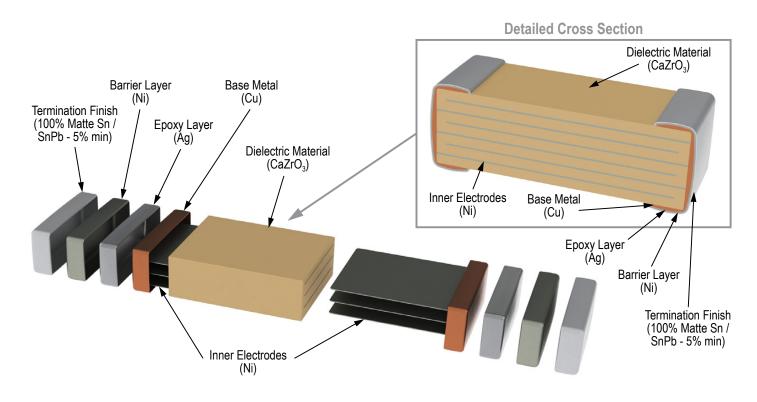
Stress	Reference	Test or Inspection Method			
Terminal Strength	JIS-C-6429	Appendix 1, Note: Force of 1.8 kg for 60 seconds.			
Board Flex	JIS-C-6429	Appendix 2, Note: Standard termination system – 2.0 mm (minimum) for all except 3 mm for C0G. Flexible termination system – 3.0 mm (minimum).			
		Magnification 50 X. Conditions:			
Solderability	J-STD-002	a) Method B, 4 hours @ 155°C, dry heat @ 235°C			
Solderability	J-31D-002	b) Method B @ 215°C category 3			
		c) Method D, category 3 @ 260°C			
Temperature Cycling	JESD22 Method JA-104	1,000 cycles (-55°C to +125°C). Measurement at 24 hours +/- 2 hours after test conclusion.			
Diagod Humidity	MIL-STD-202 Method 103	Load Humidity: 1,000 hours 85°C/85% RH and 200 VDC maximum. Add 100 K ohm resistor. Measurement at 24 hours +/- 2 hours after test conclusion.			
Biased Humidity		Low Volt Humidity: 1,000 hours 85°C/85% RH and 1.5 V. Add 100 K ohm resistor. Measurement at 24 hours +/- 2 hours after test conclusion.			
Moisture Resistance	MIL-STD-202 Method 106	t = 24 hours/cycle. Steps 7a and 7b not required. Unpowered. Measurement at 24 hours +/- 2 hours after test conclusion.			
Thermal Shock	MIL-STD-202 Method 107	-55°C/+125°C. Note: Number of cycles required – 300. Maximum transfer time – 20 seconds. Dwell time – 15 minutes. Air – Air.			
High Temperature Life	MIL-STD-202 Method 108	1,000 hours at 125°C (85°C for X5R, Z5U and Y5V) with 1.2 X rated voltage applied.			
Storage Life	MIL-STD-202 Method 108	150°C, 0 VDC for 1,000 hours.			
Vibration	MIL-STD-202 Method 204	5 g's for 20 min., 12 cycles each of 3 orientations. Note: Use 8" X 5" PCB 0.031" thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10 – 2,000 Hz			
Mechanical Shock	MIL-STD-202 Method 213	Figure 1 of Method 213, Condition F.			
Resistance to Solvents	MIL-STD-202 Method 215	Add aqueous wash chemical, OKEM Clean or equivalent.			

Storage and Handling

Ceramic chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature—reels may soften or warp and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C and maximum storage humidity not exceed 70% relative humidity. Temperature fluctuations should be minimized to avoid condensation on the parts and atmospheres should be free of chlorine and sulfur bearing compounds. For optimized solderability chip stock should be used promptly, preferably within 1.5 years of receipt.



Construction



Capacitor Marking (Optional):

Laser marking option is not available on:

- C0G, Ultra Stable X8R and Y5V dielectric devices
- EIA 0402 case size devices
- EIA 0603 case size devices with Flexible Termination option.
- · KPS Commercial and Automotive grade stacked devices.

These capacitors are supplied unmarked only.



Tape & Reel Packaging Information

KEMET offers multilayer ceramic chip capacitors packaged in 8, 12 and 16 mm tape on 7" and 13" reels in accordance with EIA Standard 481. This packaging system is compatible with all tape-fed automatic pick and place systems. See Table 2 for details on reeling quantities for commercial chips.

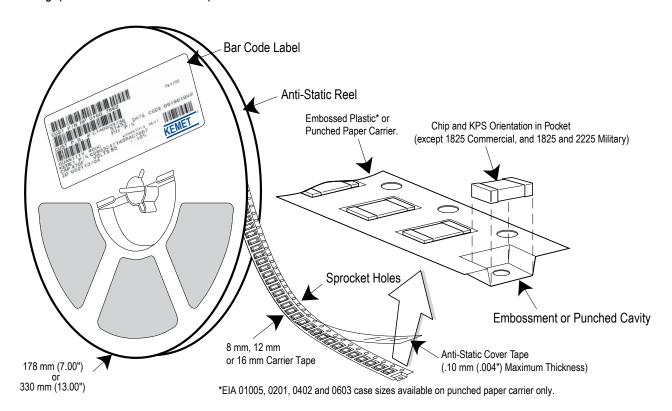


Table 5 – Carrier Tape Configuration, Embossed Plastic & Punched Paper (mm)

		Embossed Plastic		Punched Paper	
EIA Case Size	Tape size (W)*	7" Reel	13" Reel	7" Reel	13" Reel
		Pitch	(P ₁)*	Pitch (P ₁)*	
01005 – 0402	8			2	2
0603	8			4	4
0805	8	4	4	4	4
1206 – 1210	8	4	4	4	4
1805 – 1808	12	4	4		
≥ 1812	12	8	8		
KPS 1210	12	8	8		
KPS 1812 & 2220	16	12	12		
Array 0508 & 0612	8	4	4		

^{*}Refer to Figures 1 & 2 for W and P, carrier tape reference locations.

^{*}Refer to Tables 6 & 7 for tolerance specifications.



Figure 1 – Embossed (Plastic) Carrier Tape Dimensions

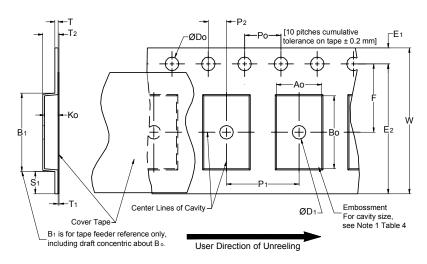


Table 6 – Embossed (Plastic) Carrier Tape Dimensions

Metric will govern

	Constant Dimensions — Millimeters (Inches)									
Tape Size	D ₀	D ₁ Minimum Note 1	E ₁	P ₀	P ₂	R Reference Note 2	S ₁ Minimum Note 3	T Maximum	T ₁ Maximum	
8 mm		1.0 (0.039)				25.0 (0.984)				
12 mm	1.5 +0.10/-0.0 (0.059 +0.004/-0.0)	1.5	1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	30	0.600 (0.024)	0.600 (0.024)	0.100 (0.004)	
16 mm	(0.0	(0.059)				(1.181)				
			Variable Dime	ensions — Mil	limeters (Inch	es)				
Tape Size	Tape Size Pitch $\begin{array}{ c c c c c c c c c c c c c c c c c c c$								& K ₀	
8 mm	Single (4 mm)	4.35 (0.171)	6.25 (0.246)	3.5 ±0.05 (0.138 ±0.002)	4.0 ±0.10 (0.157 ±0.004)	2.5 (0.098)	8.3 (0.327)			
12 mm	Single (4 mm) & Double (8 mm)	8.2 (0.323)	10.25 (0.404)	5.5 ±0.05 (0.217 ±0.002)	8.0 ±0.10 (0.315 ±0.004)	4.6 (0.181)	12.3 (0.484)	Not	te 5	
16 mm	Triple (12 mm)	12.1 (0.476)	14.25 (0.561)	7.5 ±0.05 (0.138 ±0.002)	12.0 ±0.10 (0.157 ±0.004)	4.6 (0.181)	16.3 (0.642)			

- 1. The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location and hole location shall be applied independent of each other.
- 2. The tape with or without components shall pass around R without damage (see Figure 6).
- 3. If S₄ < 1.0 mm, there may not be enough area for cover tape to be properly applied (see EIA Standard 481 paragraph 4.3 section b).
- 4. B, dimension is a reference dimension for tape feeder clearance only.
- 5. The cavity defined by A_n, B_n and K_n shall surround the component with sufficient clearance that:
 - (a) the component does not protrude above the top surface of the carrier tape.
 - (b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
 - (c) rotation of the component is limited to 20° maximum for 8 and 12 mm tapes and 10° maximum for 16 mm tapes (see Figure 3).
 - (d) lateral movement of the component is restricted to 0.5 mm maximum for 8 and 12 mm wide tape and to 1.0 mm maximum for 16 mm tape (see Figure 4).
 - (e) for KPS Series product, A₀ and B₀ are measured on a plane 0.3 mm above the bottom of the pocket.
 - (f) see Addendum in EIA Standard 481 for standards relating to more precise taping requirements.



Figure 2 – Punched (Paper) Carrier Tape Dimensions

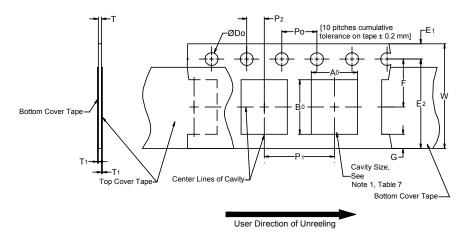


Table 7 – Punched (Paper) Carrier Tape Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)									
Tape Size	D ₀	E ₁	P ₀	P ₂	T ₁ Maximum	G Minimum	R Reference Note 2		
8 mm	1.5 +0.10 -0.0 (0.059 +0.004 -0.0)	1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	0.10 (0.004) Maximum	0.75 (0.030)	25 (0.984)		
	Variable Dimensions — Millimeters (Inches)								
Tape Size	Pitch	E2 Minimum	F	P ₁	T Maximum	W Maximum	A_0B_0		
8 mm	Half (2 mm)	6.25	3.5 ±0.05	2.0 ±0.05 (0.079 ±0.002)	1.1	8.3 (0.327)	Note 1		
8 mm	Single (4 mm)	(0.246)	(0.138 ±0.002)	4.0 ±0.10 (0.157 ±0.004)	(0.098)	8.3 (0.327)	Note 1		

- 1. The cavity defined by A_{α} , B_{α} and T shall surround the component with sufficient clearance that:
 - a) the component does not protrude beyond either surface of the carrier tape.
 - b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
 - c) rotation of the component is limited to 20° maximum (see Figure 3).
 - d) lateral movement of the component is restricted to 0.5 mm maximum (see Figure 4).
 - e) see Addendum in EIA Standard 481 for standards relating to more precise taping requirements.
- 2. The tape with or without components shall pass around R without damage (see Figure 6).



Packaging Information Performance Notes

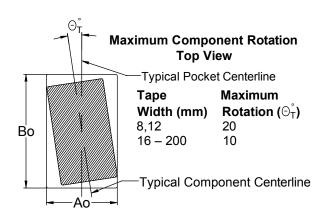
- 1. Cover Tape Break Force: 1.0 Kg minimum.
- 2. Cover Tape Peel Strength: The total peel strength of the cover tape from the carrier tape shall be:

Tape Width	Peel Strength
8 mm	0.1 to 1.0 Newton (10 to 100 gf)
12 and 16 mm	0.1 to 1.3 Newton (10 to 130 gf)

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165° to 180° from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of 300 ± 10 mm/minute.

3. Labeling: Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. *Refer to EIA Standards 556 and 624.*

Figure 3 – Maximum Component Rotation



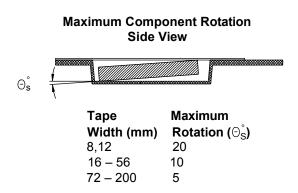


Figure 4 - Maximum Lateral Movement

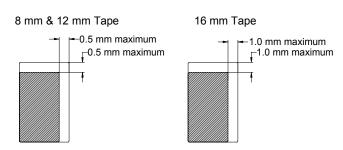


Figure 5 - Bending Radius

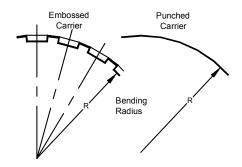
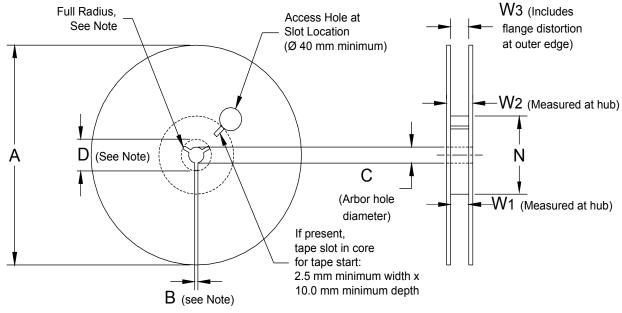




Figure 6 – Reel Dimensions



Note: Drive spokes optional; if used, dimensions B and D shall apply.

Table 8 - Reel Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)							
Tape Size	A	B Minimum C		D Minimum			
8 mm	178 ±0.20			20.2 (0.795)			
12 mm	(7.008 ±0.008) or	1.5 (0.059)	13.0 +0.5/-0.2 (0.521 +0.02/-0.008)				
16 mm	330 ±0.20 (13.000 ±0.008)	,	,	(- 22)			
	Variable Dimensions — Millimeters (Inches)						
Tape Size	Tape Size N Minimum W ₁ W ₂ Maximum						
8 mm		8.4 +1.5/-0.0 (0.331 +0.059/-0.0)	14.4 (0.567)				
12 mm	50 (1.969)	12.4 +2.0/-0.0 (0.488 +0.078/-0.0)	18.4 (0.724)	Shall accommodate tape width without interference			
16 mm		16.4 +2.0/-0.0 (0.646 +0.078/-0.0)	22.4 (0.882)				



Figure 7 – Tape Leader & Trailer Dimensions

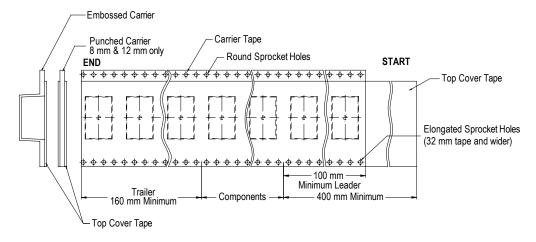
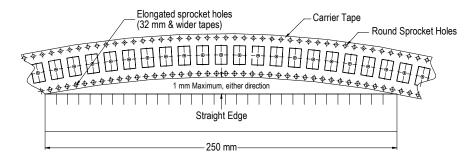
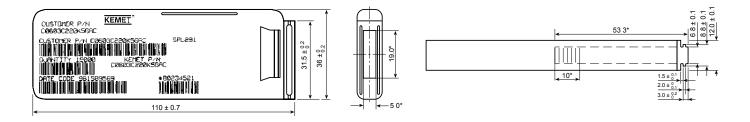


Figure 8 - Maximum Camber



Bulk Cassette Packaging (Ceramic Chips Only)

Meets Dimensional Requirements IEC–286 and EIAJ 7201 *Unit mm *Reference*



Capacitor Dimensions for Bulk Cassette

Cassette Packaging - Millimeters

EIA Size Code	Metric Size Code	L Length	W Width	B Bandwidth	S Separation Minimum	T Thickness	Number of Pieces/Cassette
0402	1005	1.0 ±0.05	0.5 ±0.05	0.2 to 0.4	0.3	0.5 ±0.05	50,000
0603	1608	1.6 ±0.07	0.8 ±0.07	0.2 to 0.5	0.7	0.8 ±0.07	15,000



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